

## PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT												
NATURE OF CONVEYANCE:	ASSIGNMENT												
CONVEYING PARTY DATA													
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>Ming-Hong Huang</td> <td>09/23/2013</td> </tr> <tr> <td>Pei-Hsiang Tseng</td> <td>09/23/2013</td> </tr> <tr> <td>Pei-Hsiu Shih</td> <td>09/25/2013</td> </tr> <tr> <td>Chia-Hung Yu</td> <td>09/23/2013</td> </tr> <tr> <td>Min-Shun Huang</td> <td>09/18/2013</td> </tr> </tbody> </table>		Name	Execution Date	Ming-Hong Huang	09/23/2013	Pei-Hsiang Tseng	09/23/2013	Pei-Hsiu Shih	09/25/2013	Chia-Hung Yu	09/23/2013	Min-Shun Huang	09/18/2013
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<table border="1"> <tr> <td>Name:</td> <td>Epistar Corporation</td> </tr> <tr> <td>Street Address:</td> <td>5 Li-Hsin 5th Road</td> </tr> <tr> <td>Internal Address:</td> <td>Science-based Industrial Park</td> </tr> <tr> <td>City:</td> <td>Hsinchu</td> </tr> <tr> <td>State/Country:</td> <td>TAIWAN</td> </tr> <tr> <td>Postal Code:</td> <td>300</td> </tr> </table>		Name:	Epistar Corporation	Street Address:	5 Li-Hsin 5th Road	Internal Address:	Science-based Industrial Park	City:	Hsinchu	State/Country:	TAIWAN	Postal Code:	300
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CORRESPONDENCE DATA													
<p>Fax Number: 7325309808  <i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i></p> <p>Phone: 732-530-9404</p> <p>Email: psdocketing@pattersonsheridan.com,        ktaboada@pattersonsheridan.com</p> <p>Correspondent Name: Patterson &amp; Sheridan - EPISTAR</p> <p>Address Line 1: 3040 Post Oak Boulevard</p> <p>Address Line 2: Suite 1500</p> <p>Address Line 4: Houston, TEXAS 77056</p>													
ATTORNEY DOCKET NUMBER:	EPIS/0043												

OP \$40.00 14038696

NAME OF SUBMITTER:	Keith Taboada
Signature:	/Keith Tabaoda/
Date:	09/26/2013
	This document serves as an Oath/Declaration (37 CFR 1.63).
<p>Total Attachments: 6 source=EPIS0043US_Assignment#page1.tif source=EPIS0043US_Assignment#page2.tif source=EPIS0043US_Assignment#page3.tif source=EPIS0043US_Assignment#page4.tif source=EPIS0043US_Assignment#page5.tif source=EPIS0043US_Assignment#page6.tif</p>	

**ASSIGNMENT FOR APPLICATION FOR PATENT**

WHEREAS:

Names and Addresses of Inventors:

1)	Ming-Hong Huang 5 Li-hsin 5th Rd., Science-based Industrial Park, Hsinchu, TW Hsinchu City	2)	Pei-Hsiang Tseng 5 Li-hsin 5th Rd., Science-based Industrial Park, Hsinchu, TW Hsinchu City
3)	Pei-Hsiu Shih 5 Li-hsin 5th Rd., Science-based Industrial Park, Hsinchu, TW Hsinchu City	4)	Chia-Hung Yu 5 Li-hsin 5th Rd., Science-based Industrial Park, Hsinchu, TW Hsinchu City
5)	Min-Shun Huang 5 Li-hsin 5th Rd., Science-based Industrial Park, Hsinchu, TW Hsinchu City		

(hereinafter referred to as Assignors), have invented a certain invention entitled:

**AN APPARATUS FOR MEASURING THE OPTOELECTRONIC CHARACTERISTICS  
OF LIGHT-EMITTING DIODE**

enclosed herewith or for which application for Letters Patent in the United States was filed on:  
\_\_\_\_\_, under Serial No. \_\_\_\_\_; and

WHEREAS, Epistar Corporation, a corporation of Taiwan, Republic of China, having a place of business at 5 Li-Hsin 5<sup>th</sup> Rd., Science-based Industrial Park, Hsinchu, Taiwan 300, R.O.C. (hereinafter referred to as Assignee), is desirous of acquiring the entire right, title and interest in and to said application (hereinafter referred to as Application), and the invention disclosed therein (hereinafter referred to as Invention), and in and to all embodiments of the Invention, heretofore conceived, made or discovered by said Assignors, and in and to any and all patents, inventor's certificates and other forms of protection (hereinafter referred to as Patents) thereon granted in any and all countries and groups of countries.

NOW, THEREFORE, in consideration of good and valuable consideration acknowledged by said Assignors to have been received in full from said Assignee:

1. Said Assignors hereby sell, assign, transfer and convey to Assignee the full and exclusive right, title and interest (a) in and to said Application and said Invention; (b) in and to all rights to apply for patents on said Invention in any and all countries pursuant to the International Convention for the Protection of Industrial Property or otherwise; (c) in and to any and all Applications filed and any and all Patents granted on said Invention in any and all countries and groups of countries, including each and every Application filed and each and every Patent granted on any application which is a conventional, division, substitution, or continuation of said Application; and (d) in and to each and every reissue or extension of any of said Patents.

2. Said Assignors hereby covenant and agree to cooperate with said Assignee to enable said Assignee to enjoy to the fullest extent the right, title and interest to said Invention herein conveyed in any and all countries and groups of countries. Such cooperation by said Assignors shall include prompt

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production of pertinent facts and documents, giving testimony, execution of petitions, oaths, specifications, declarations or other papers, and other assistance all to the extent deemed necessary or desirable by said Assignee (a) for perfecting in said Assignee the right, title and interest herein conveyed; (b) for prosecuting any of said applications; (c) for filing and prosecuting substitute, conventional, divisional, continuing or additional applications covering said Invention; (d) for filing and prosecuting applications for reissuance of any of said Patents; (e) for interference or other priority proceedings involving said Invention; and (f) for legal proceedings involving said Invention and any application therefore and any Patents granted thereon, including without limitation opposition proceedings, cancellation proceedings, priority contests, public use proceedings, infringement actions and court actions; provided, however, that the expense incurred by said Assignors in providing such cooperation shall be paid for by said Assignee.

3. The term and covenants of this agreement shall inure to the benefit of said Assignee, its successors, assigns and other legal representatives, and shall be binding upon said Assignors, their respective heirs, legal representatives and assigns.

4. Said Assignors hereby warrant and represent that they have not entered and will not enter into any assignment, contract, or understanding in conflict herewith.

5. In the event that the filing date and/or Application No. of said Invention are not entered above at the time Assignors execute this document, and if such information is deemed necessary, Assignors hereby authorize and request the attorney/agent(s) of **Patterson & Sheridan, LLP**, 595 Shrewsbury Avenue, Suite 100, Shrewsbury, NJ 07702 to insert above the filing date and/or Application No. of said application.

6. This declaration is directed to the attached application, or (if following box is checked):

As a below named inventor, I hereby declare that:

The above-identified application was made or authorized to be made by me;

I believe that I am the original inventor or an original joint inventor of a claimed invention in the application; and

I acknowledge that any willful false statement made in this declaration is punishable under section 1001 of title 18 by fine or imprisonment of not more than 5 years, or both.

IN WITNESS WHEREOF, the said Assignors have executed and delivered this instrument to said Assignee on the dates indicated below.

1)	<u>2013.09.23</u> (DATE)	<u>Ming-Hong Huang</u> Ming-Hong Huang
2)	<u>2013.09.23</u> (DATE)	<u>Pei-Hsiang Tseng</u> Pei-Hsiang Tseng
3)	_____ (DATE)	_____ Pei-Hsiu Shih
4)	<u>2013.09.23</u> (DATE)	<u>Chia-Hung Yu</u> Chia-Hung Yu

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5) 2013.09.18 (DATE) Min-Shun Huang  
Min-Shun Huang

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WHEREAS:

Names and Addresses of Inventors:

1)	Ming-Hong Huang 5 Li-hsin 5th Rd., Science-based Industrial Park, Hsinchu, TW Hsinchu City	2)	Pei-Hsiang Tseng 5 Li-hsin 5th Rd., Science-based Industrial Park, Hsinchu, TW Hsinchu City
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1)	_____ (DATE)	_____
		Ming-Hong Huang
2)	_____ (DATE)	_____
		Pei-Hsiang Tseng
3)	<u>2017.9.25</u> (DATE)	<u>Pei-Hsiu Shih</u>
		Pei-Hsiu Shih
4)	_____ (DATE)	_____
		Chia-Hung Yu

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5) \_\_\_\_\_ (DATE) \_\_\_\_\_  
Min-Shun Huang